BUSSMANN SERIES

CC06FA

Automotive grade fast-acting chip fuse











Product features

- · AEC-Q200 qualified
- 0603 (1608 metric) compact design utilizes less board space
- · Rapid interruption of excessive current
- · Compatible with reflow and wave solder
- · Rugged ceramic and glass construction
- · Excellent environmental integrity
- · One time positive disconnect
- · High breaking capacity up to 63 V
- Moisture sensitivity level (MSL) :1

Applications

Automotive

- Battery management systems (BMS)
- · Central body control module
- · Doors, window lift and seat control
- · Digital instrument cluster
- In-vehicle infotainment (IVI) and navigation
- Electric pumps, motor control and auxiliaries
- Powertrain control module (PCU)/engine control unit (ECU)
- Transmission control unit (TCU)

Agency information

- UL Recognized File: File E19180
- AEC-Q200 qualified

Ordering

• Use ordering codes (see page 3 for details)

Packaging sufixes

-TR (5,000 parts in paper tape on a 178 mm (7") reel)



Electrical characteristics

Amp Rating	% of Amp Rating	Opening Time
500 mA – 1.5 A	100%	4 hours minimum
500 mA – 1.5 A	200%	60 seconds maximum

Product specifications

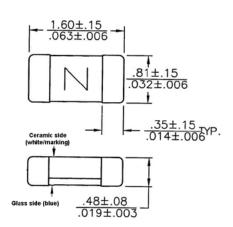
Part Number ⁵	Current rating (A)	Voltage rating (Vdc)	Interrupting rating ¹ (A)	Typical DC cold resistance² (Ω)	Typical pre-arcing ³ I ² t (A ² s)	Typical voltage drop (V)	Part marking
CC06FA500mA	0.5	63	50	1.025	0.0019	0.60	F
CC06FA750mA	0.75	63	50	0.510	0.003	0.50	G
CC06FA1A	1	63	50	0.150	0.007	0.211	Н
CC06FA1.25A	1.25	63	50	0.132	0.008	0.201	J
CC06FA1.5A	1.5	63	50	0.086	0.0319	0.138	K

- 1. DC interrupting rating measured at rated voltage, time constant less than 50 microseconds, battery source
- 2. DC cold resistance measured at <10% of rated current
- 3. Typical pre-arcing I²t measured with a battery bank at rated dc voltage, 10x-rated current, not to exceed IR, time constant of calibrated circuit less than 50 microsecond
- 4. Typical voltage drop measured at rated current after temperature stabilizes
- 5. Part Number Definition: CC06FAxxx-R

CC06FA = Product code and size

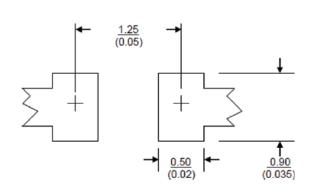
xxx - Ampere rating (mA or A)

Dimensions<u>-mm</u>

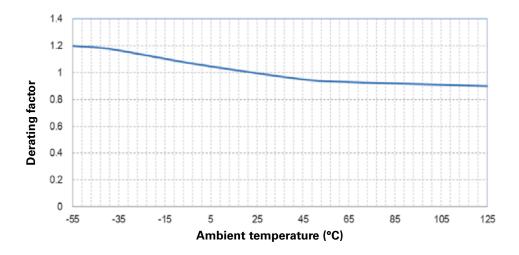


Fuse to be installed with ceramic side up (white/marking)

Recommended pad layout



Temperature derating curve



Environmental data

Operating temperature: -55 °C to +125 °C (with derating)

Storage temperature (component): -55 °C to +125 °C

Life test: MIL-STD-202, Method 108A, except circulating air environment at +125 °C ±2 °C, apply 60% rated current for 1000 hours

Load humidity test: MIL-STD-202, Method 103B except: environmental chamber 85%+2% relative humidity at +85 °C ±2 °C, 10% of rated dc current, at any voltage less than or equal to rated voltage for 1000 hours

Terminal strength test: Force of 1.8 kg for 60 seconds

TBoard flex test: Downward force is applied to cause a 2 mm deflection for 1 minute (no physical evidence of mechanical or physical damage, change in resistance < 5%)

Thermal shock test: MIL-STD-202, Method 107D, -55 °C to +125 °C, 200 cycles

Mechanical shock test: MIL-STD-202, Method 213 condition C, 100 g's half-sine for 6 seconds

High frequency vibration test: MIL-STD-202, Method 204, 5 g's for 20 minutes, 12 cycles each of 3 orientations ,10 to 2000 Hz

Resistance to solvents test: MIL-STD-202, Method 215A

High temperature exposure: 1000 hours at +125 °C unpowered

Resistance to solder heat: MIL-STD-202 Method 210 condition B

Solderability: ANSI/J-STD-002, Dip and look test: Test B Wetting balance test: Test F

Resistance to dissolution of metalization test: Test D

Ordering codes

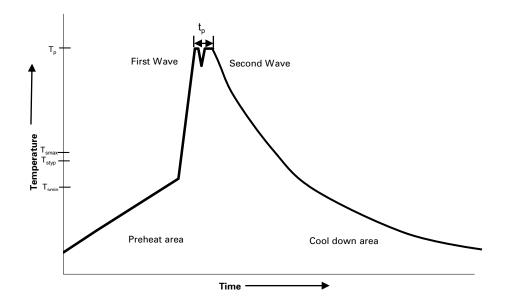
The ordering code is the part number replacing the "with a "-" plus adding the packaging suffix.

Packaging suffix

-TR (5,000 parts in paper tape on a 178 mm (7") reel)

	Ordering code
Part Number	-TR option
CC06FA500mA	CC06FA500mA-TR
CC06FA750mA	CC06FA750mA-TR
CC06FA1A	CC06FA1A-TR
CC06FA1.25A	CC06FA1-25A-TR
CC06FA1.5A	CC06FA1-5A-TR

Wave solder profile



Reference EN 61760-1:2006

Profile feat	ure	Standard SnPb solder	Lead (Pb) free solder
Preheat	• Temperature min. (T _{smin})	100 °C	100 °C
	Temperature typ. (T _{styp})	120 °C	120 °C
	• Temperature max. (T _{smax})	130 °C	130 °C
	Time (T _{smin} to T _{smax}) (t _s)	70 seconds	70 seconds
Δ preheat to	max Temperature	150 °C max.	150 °C max.
Peak tempera	ature (Tp)*	235 °C − 260 °C	250 °C − 260 °C
Time at peak	temperature (t _p)	10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave
Ramp-down r	ate	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max
Time 25°C to	25°C	4 minutes	4 minutes

Manual solder

+350 °C (4-5 seconds by soldering iron), generally manual/hand soldering is not recommended

Solder reflow profile

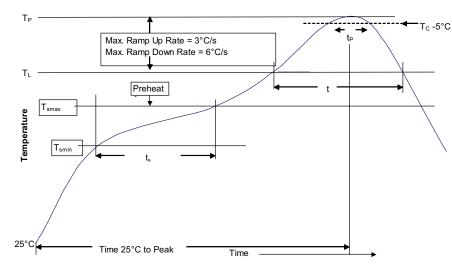


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C
• Temperature max. (T _{smax})	150 °C	200 °C
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L) Time (t_L) maintained above T_L	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time (t _p)* within 5 °C of the specified classification temperature (T _C)	20 seconds*	30 seconds*
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

^{*} Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

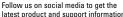
Eaton Electronics Division

1000 Eaton Boulevard Cleveland, OH 44122 United States Eaton.com/electronics

© 2019 Eaton All Rights Reserved Printed in USA Publication No. 11003 BU-MC19130 November 2019

Eaton is a registered trademark.

All other trademarks are property of their respective owners.













X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Surface Mount Fuses category:

Click to view products by Eaton manufacturer:

Other Similar products are found below:

FHC20402ADTP NFVC6125S0R50TRF SFT-125MA TF16SN2.00TTD TF16SN3.15TTD TR/3216LR-500MA CCP2B20TTE

FCC16501ABTP FHC16322ADTP 0308.250UR 0308.375UR 0308.500UR 030801.5UR FCC16202ABTP 03081.25UR F0603G0R03FNTR

SKY87604-11 3404.0110.22 SEF 0.375A 125V (G) 1211015 S1206-F-3.0A 9321315278 S0603-F-4.0A SMT1315AP 0603TD-4A

1240FH-30A R451003.L R451.500L R451001.L 3-103-119 3-103-123 3-103-127 0154002.DRL 0154008.DRL 0154.500DRL 189140.1,25

189140.0,8 189140.0,4 189140.0,63 189140.0,25 0468003.WR 0494001.NRHF 0494002.NRHF 0494003.NRHF 049402.5NRHF

049403.5NRHF 0494.250NRHF 0494.375NRHF 0494.500NRHF CF06V3T1R60